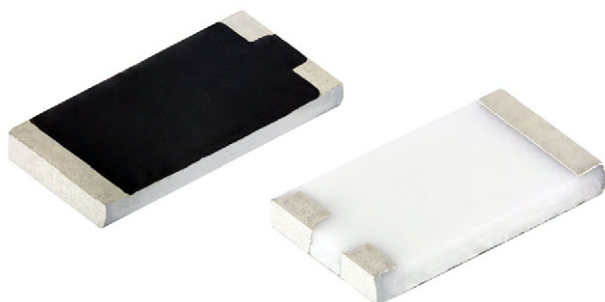


Thick Film Chip Dividers, Medium Voltage



FEATURES

- AEC-Q200 qualified
- Voltage up to 1415 V
- Precision to $\pm 0.5\%$ with low TCR tracking to 10 ppm/°C utilizing thick film technology
- Wide range of resistance value and ratios
- Termination style:
3-sided wraparound termination
- Termination material:
solder-coated nickel barrier
- Sulfur resistant verified by testing to EIA 977 test condition A
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



LINKS TO ADDITIONAL RESOURCES



APPLICATIONS

- Automotive:
 - EV charging for over voltage protection
 - Voltage dividers
 - On-board chargers
 - DC/DC converters
 - Battery management

STANDARD ELECTRICAL SPECIFICATIONS

GLOBAL MODEL	CASE SIZE	POWER RATING $P_{70^\circ\text{C}}$ W	MAXIMUM WORKING VOLTAGE ⁽¹⁾ V	RESISTANCE RANGE ⁽²⁾ Ω	TOLERANCE ⁽³⁾ $\pm\%$	RATIO RANGE $(R_1 + R_2)/R_2$	TCR TRACKING (-55 °C to +155 °C) \pm ppm/°C
CDMA	2512	1	1415	500K to 50M	0.5, 1, 2, 5, 10	100:1 to 600:1	10 to 50

Notes

- (1) Continuous working voltage shall be $\sqrt{P \times R}$ or maximum working voltage, whichever is less
- (2) Resistance values are calibrated at 100 V_{DC}. Calibration at other voltages available upon request
- (3) Contact factory for tighter tolerances

GLOBAL PART NUMBER INFORMATION

New Global Part Numbering: **CDMA20K0J1000GEB** (preferred part number format)

C	D	M	A	2	0	K	0	J	1	0	0	0	G	E	B		
GLOBAL MODEL		RESISTANCE VALUE (R ₁)		TOLERANCE		RATIO (R ₁ + R ₂) / R ₂		RATIO TOLERANCE		SOLDER TERMINATION		PACKAGING		SPECIAL			
CDMA = CDMA2512		K = kΩ M = MΩ 20K0 = 20 kΩ 800K = 800 kΩ 1M00 = 1 MΩ		D = ± 0.5 % F = ± 1 % G = ± 2 % J = ± 5 % K = ± 10 %		3 digit significant figure, followed by a multiplier 1000 = 100:1 2000 = 200:1		D = ± 0.5 % F = ± 1 % G = ± 2 % H = ± 3 % J = ± 5 %		E = Sn100		B = bulk (250 pcs max.) F = T / R (full reel) 1 = T / R (1000 pcs) 5 = T / R (500 pcs) T = T / R (250 pcs min.)					

Note

- For additional information on packaging, refer to the "Surface-Mount Resistor Packaging" document (www.vishay.com/doc?31543)

VOLTAGE COEFFICIENTS AND RATIO TRACKING INFORMATION (Typical)

RESISTANCE (Ω)	RATIO (MAXIMUM)	VCR (ppm/V)	TCR TRACKING (ppm/°C) -55 °C to +155 °C
500K	100:1	-10	± 20
15M	250:1	-10	± 10
50M	600:1	-10	-50 to 0

Note

- Contact factory for other ratios

MATERIAL SPECIFICATIONS

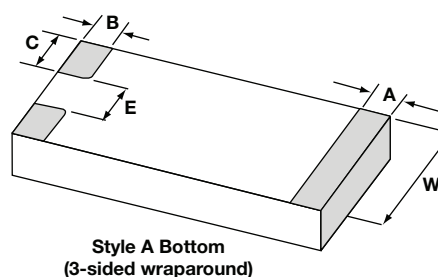
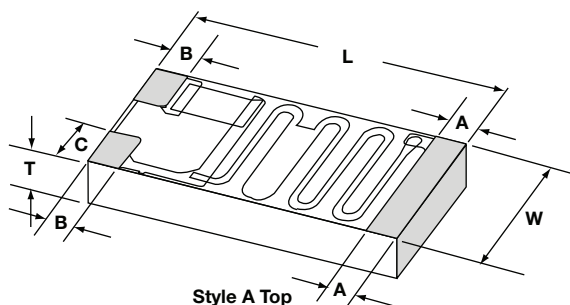
Resistive element	Ruthenium oxide
Encapsulation	Epoxy
Substrate	96 % alumina
Termination	Solder-coated nickel barrier terminations standard
Solder finish	Pure tin

ENVIRONMENTAL SPECIFICATIONS

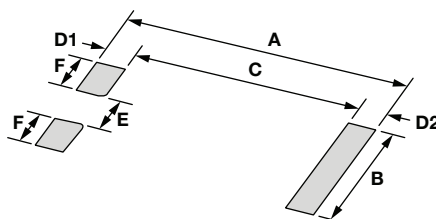
Operating temperature	-55 °C to +155 °C
Life	Less than 0.5 % change when tested at full rated power

Note

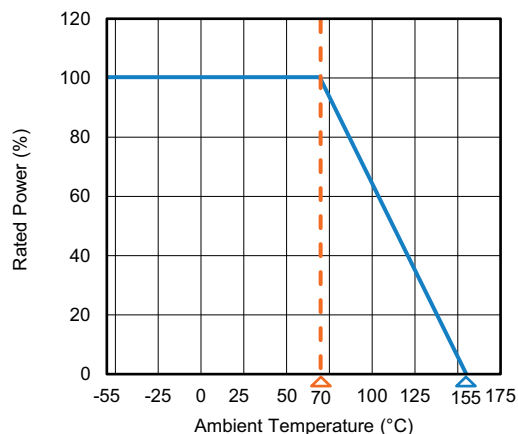
- Reference only: not for all values specified. Consult factory for your size and value

DIMENSIONS in inches (millimeters)


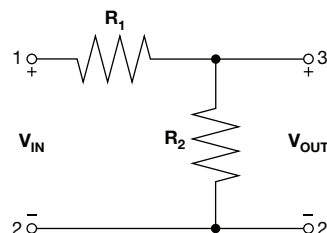
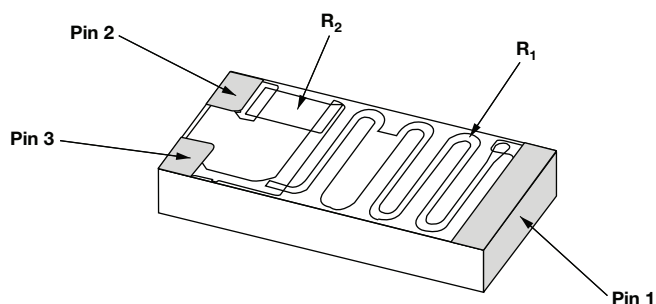
TERMINATION	LENGTH (L) ± 0.006 (0.152)	WIDTH (W) ± 0.006 (0.152)	THICKNESS (T) ± 0.005 (0.127)	A ± 0.005	B ± 0.005	C ± 0.005	E ± 0.010
Style A (3-sided wraparound)	0.250	0.126	0.025	0.025	0.025	0.040	0.046

RECOMMENDED SOLDER PAD LAYOUT


MODEL	DIMENSIONS in inches (millimeters)						
	A	B	C	D1	D2	E	F
CDMA2512	0.275 (6.99)	0.126 (3.20)	0.190 (4.83)	0.050 (1.27)	0.035 (0.89)	0.040 (1.02)	0.046 (1.17)

DERATING CURVE

Note

- Reference only: not for all values specified. Consult factory for your specific value

SCHEMATIC

PERFORMANCE

TEST	CONDITIONS OF TEST	TEST LIMITS
High temperature exposure (storage)	MIL-STD-202, method 108, 2000 h at T = 155 °C at 0 % power	± 1.0 %
Thermal shock	JESD22 method JA-104, 2000 cycles (-55 °C to +150 °C), dwell time = 15 min, maximum transfer time = 20 s air to air	± 1.0 %
Moisture resistance	MIL-STD-202, method 106	± 1.0 %
Biased humidity	MIL-STD, method 103, 2000 h 85 °C / 85 % RH Note: specified conditions: 10 % of rated voltage	± 2.0 %
Operational life	MIL-STD-202, method 108, 2000 h, T _a = 125 °C at rated power	± 1.0 %
Resistance to solvents	MIL-STD-202, method 215	No damage to parts
Mechanical shock	MIL-STD-202, method 213, figure 1, SMD, condition C	± 0.5 %
Vibration	MIL-STD-202, method 204, 5 g's for 20 minutes. 12 cycles each of 3 orientations	± 0.5 %
Resistance to solder heat	MIL-STD-202, method 210, condition J	± 1.0 %
Solderability	J-STD-002, method B1, 4 h at 155 °C dry heat, solder at 245 °C, magnification 50 x	> 95 % coverage
Flammability	UL 94	V-0
Board flex	AEC-Q200-005 2 mm min.	± 1.0 %
Terminal strength (SMD)	AEC-Q200-006 force of 1.8 kg for 60 s	± 1.0 %



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